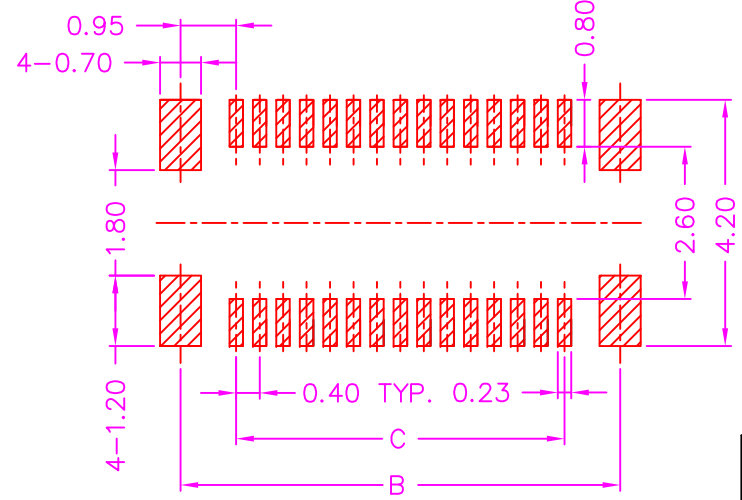
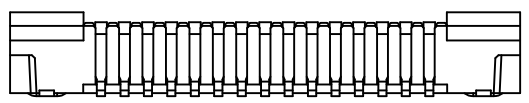
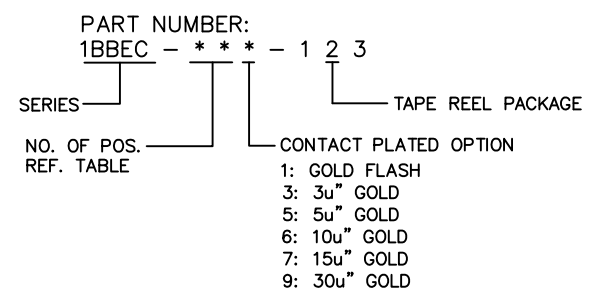


**MATERIALS**

HOUSING: HI-TEMP. PLASTIC (UL 94V-0), BLACK  
 SOLDER PAD: COPPER ALLOY, TIN PLATING  
 TERMINAL: COPPER ALLOY, GOLD PLATED

**SPECIFICATION**

CURRENT RATING: 0.3 AMP MAX  
 DIELECTRIC WITHSTANDING: 250V AC FOR ONE MINUTE  
 CONTACT RESISTANCE: 80m OHMS MAX  
 INSULATION RESISTANCE: 100M OHMS MIN AT DC 250V  
 OPERATION TEMPERATURE: -40°C+85°C



**TABLE**

POS.	DIMENSION		
	A	B	C
10	4.70	3.50	1.60
16	5.90	4.70	2.80
24	7.50	6.30	4.40
26	7.90	6.70	4.80
30	8.70	7.50	5.60
34	9.50	8.30	6.40
36	9.90	8.70	6.80
46	11.90	10.70	8.80

**P.C.B. LAYOUT  
 TOP VIEW ±0.05**

MATTING WITH DRAWING NO: 1BBEC-004

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TOLERANCES	TITLE	BOARD TO BOARD CONNECTOR SERIES				
X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		BTB, 0.40mm PITCH, PCB MOUNT, SMT, FEMALE WITH PAD, METING HEIGHT 1.50mm				
	DRAWN BY	CHECKED BY	APPROVED BY			
	<i>Tina</i>	<i>Lion</i>	<i>Benson</i>			
10165	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet
	MM	NONE	A4	1BBEC-003	A	1/1

A	RELEASE	2014.12.19
REV.	DESCRIPTION	DATE